

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 89518
LIN, Mou-Shiung, et al. : Confirmation Number: 6103
Application No.: 10/055,560 : Group Art Unit: 2813
Filed: January 22, 2002 : Examiner: MITCHELL, James M.
:

For: INTEGRATED CHIP PACKAGE STRUCTURE USING METAL SUBSTRATE AND
METHOD OF MANUFACTURING THE SAME

AMENDMENT

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Commissioner for Patents
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CERTIFICATE OF ELECTRONIC TRANSMISSION

I hereby certify that this correspondence is being electronically-transmitted to
the United States Patent and Trademark Office on January 21, 2011.
/Nicole San Nicolas/
Nicole San Nicolas

Sir:

Entry of the following amendments and consideration of the following remarks are respectfully
requested.

Amendments to the claims are reflected in the listing of claims which begins on page 2
of this paper.

Remarks begin on page 9 of this paper.

An **Appendix** is attached after the last page, which shows the status of related cases.